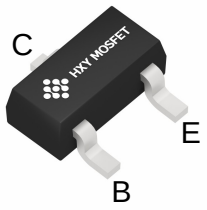
FMMT4240

NPN Plastic-Encapsulate Transistors

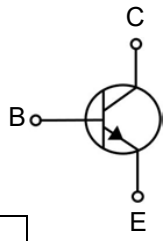
Features

IC = 2A Continuous Collector Current

350mW Power Dissipation



SOT-23



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
FMMT4240	SOT-23	619	3000

Maximum Ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	50	V
V_{CEO}	Collector-Emitter Voltage	50	V
V_{EBO}	Emitter-Base Voltage	5	V
I_C	Collector Current -Continuous	2	A
P_C	Power Dissipation	0.35	W
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	357	°C/W
P_{CM}	Maximum Power Dissipation (note 1)	0.625	W
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient (note 1)	200	°C/W
T_J, T_{stg}	Operation Junction and Storage Temperature Range	-55~+150	°C

Electrical Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	I_C=100μA,I_E=0	50			V
Collector-emitter breakdown voltage (note 2)	$V_{(BR)CEO}$	I_C=10mA,I_B=0	50			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	I_E=100μA ,I_C=0	5			V
Collector cut-off current	I_{CBO}	V_{CB}=40V,I_E=0			100	nA
Emitter cut-off current	I_{EBO}	V_{EB}=4V,I_C=0			100	nA
DC current gain (note 2)	$h_{FE(1)}$	V_{CE}=2V, I_C=10mA	200			
	$h_{FE(2)}$	V_{CE}=2V, I_C=0.2A	300			
	$h_{FE(3)}$	V_{CE}=2V, I_C=1A	200			
	$h_{FE(4)}$	V_{CE}=2V, I_C=2A	100			
	$h_{FE(5)}$	V_{CE}=2V, I_C=6A		40		
Collector-emitter saturation voltage (note 2)	$V_{CE(sat)1}$	I_C=0.1A,I_B=10mA			20	mV
	$V_{CE(sat)2}$	I_C=1A,I_B=10mA			200	mV
	$V_{CE(sat)3}$	I_C=2A,I_B=100mA			220	mV
Base-emitter saturation voltage (note 2)	$V_{BE(sat)}$	I_C=2A,I_B=50mA			1	V
Base-emitter on voltage (note 2)	$V_{BE(on)}$	I_C=2A, V_{CE}=2V			1	V
Output capacitance	C_{ob}	V_{CB}=10V, f=1MHz			20	pF
Turn-on time	$t_{(on)}$	V_{CC}=10V, I_C=1A, I_{B1}=-I_{B2}=10mA		170		ns
Turn-off time	$t_{(off)}$			750		ns
Transition frequency	f_T	V_{CE}=10V,I_C=50mA, f=100MHz	100			MHz

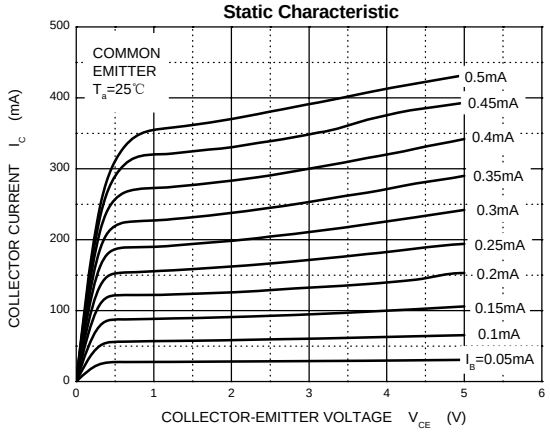
Notes :

1.Maximum power dissipation is calculated assuming that the device is mounted on a ceramic substrate measuring 15x15x0.6mm.

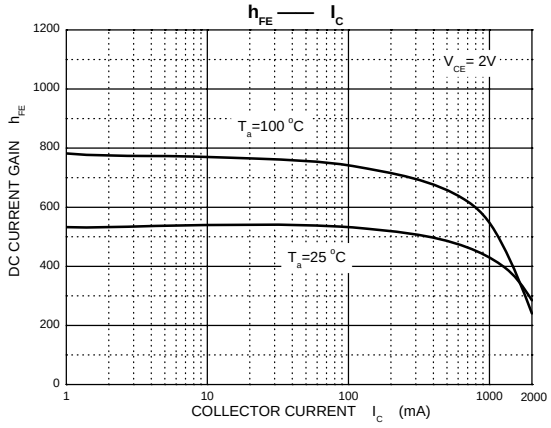
2. Pulse test: Pulse width≤300μs,duty cycle≤2.0%.

Typical Characteristics

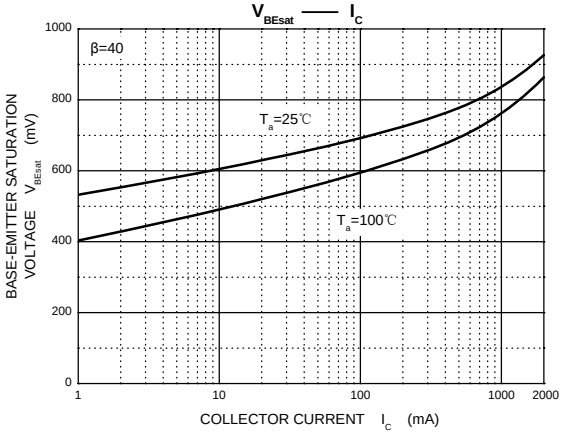
Static Characteristic



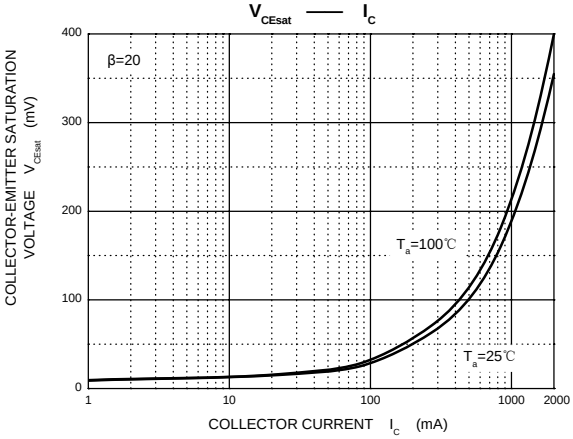
hFE —— IC



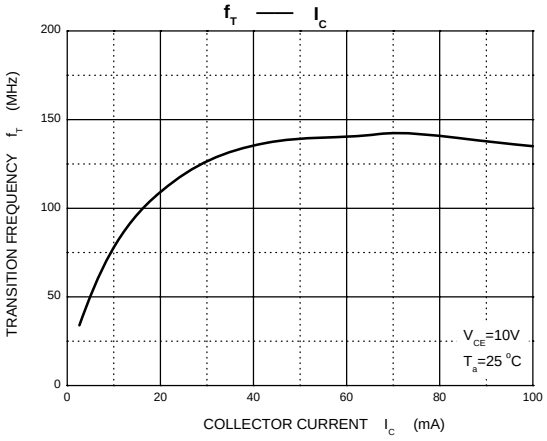
VBEsat —— IC



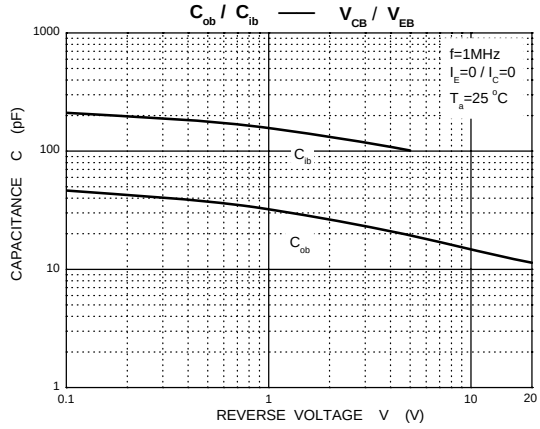
VCEsat —— IC



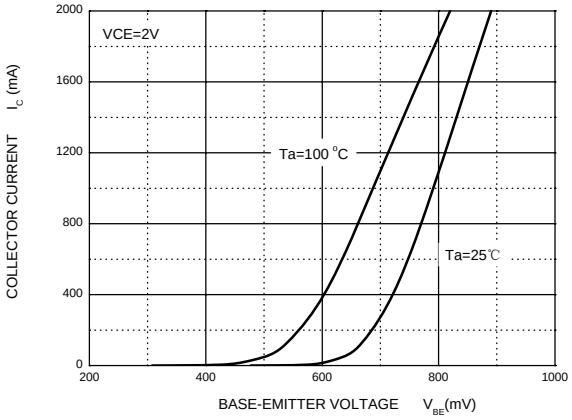
fT —— IC



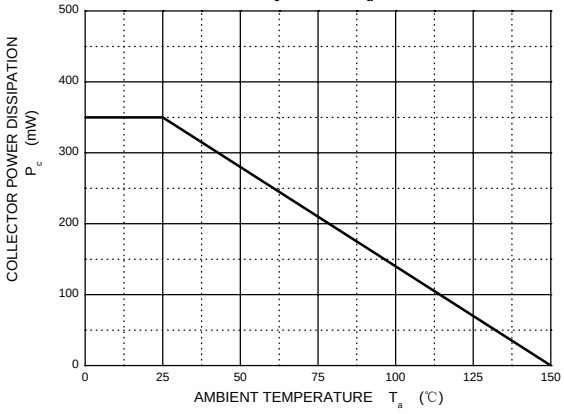
Cob / Cib —— VCB / VEB



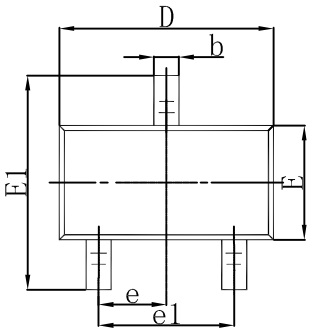
VBE —— IC

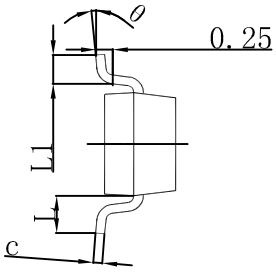


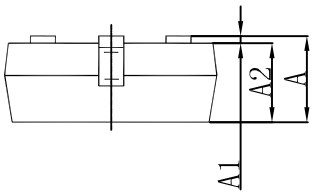
Pc —— Ta



SOT-23 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

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